

3.3V CMOS 12-BIT TO 24-BIT REGISTERED BUS EXCHANGER WITH 3-STATE OUTPUTS AND BUS-HOLD

IDT74ALVCH16269

FEATURES:

- 0.5 MICRON CMOS Technology
- Typical tsk(o) (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- Vcc = 3.3V ± 0.3V, Normal Range
- Vcc = 2.7V to 3.6V, Extended Range
- Vcc = $2.5V \pm 0.2V$
- CMOS power levels (0.4µ W typ. static)
- · Rail-to-Rail output swing for increased noise margin
- Available in SSOP, TSSOP, and TVSOP packages

DRIVE FEATURES:

- High Output Drivers: ±24mA (A port)
- Suitable for heavy loads

APPLICATIONS:

- 3.3V high speed systems
- 3.3V and lower voltage computing systems

DESCRIPTION:

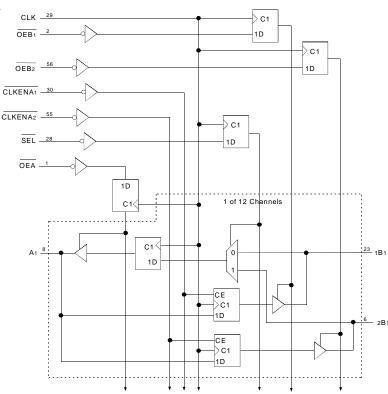
This 12-bit to 24-bit registered bus exchanger is used in applications in which two separate ports must be multiplexed onto, or demultiplexed from, a single port. It is particularly suitable as an interface between synchronous DRAMs and high-speed microprocessors.

Data is stored in the internal B-port registers on the low-to-high transition of the clock (CLK) input when the appropriate clock-enable (CLKENA) inputs are low. Proper control of these inputs allows two sequential 12-bit words to be presented as a 24-bit word on the B-port. For data transfer in the B-to-A direction, a single storage register is provided. The select SEL line selects 1B or 2B data for the A outputs. The register on the A output permits the fastest possible data transfer, thus extending the period during which the data is valid on the bus. The control terminals are registered so that all transactions are synchronous with CLK. Data flow is controlled by the active-low output enables (OEA, OEB1 and OEB2).

The ALVCH16269 has been designed with a ± 24 mA output driver. This driver is capable of driving a moderate to heavy load while maintaining speed performance.

The ALVCH16269 has "bus-hold" which retains the inputs' last state whenever the input goes to a high impedance. This prevents floating inputs and eliminates the need for pull-up/down resistors.

FUNCTIONAL BLOCK DIAGRAM

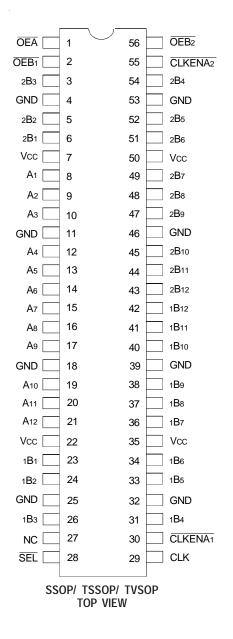


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INDUSTRIAL TEMPERATURE RANGE

PINCONFIGURATION



CAPACITANCE (TA = +25°C, F = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Тур.	Max.	Unit
CIN	Input Capacitance	VIN = 0V	5	7	рF
Соит	Output Capacitance	VOUT = 0V	7	9	рF
CI/O	I/O Port Capacitance	VIN = 0V	7	9	pF

NOTE:

1. As applicable to the device type.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +4.6	V
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	V
Tstg	Storage Temperature	–65 to +150	°C
Ιουτ	DC Output Current	-50 to +50	mA
Ік	Continuous Clamp Current, VI < 0 or VI > Vcc	±50	mA
Іок	Continuous Clamp Current, Vo < 0	-50	mA
ICC ISS	Continuous Current through each Vcc or GND	±100	mA

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 2. Vcc terminals.
- 3. All terminals except Vcc.

FUNCTION TABLES⁽¹⁾

OUTPUTENABLE

	Inputs		Outp	outs
CLK	ŌĒĀ	OEBx	Ax	1 Bx , 2 Bx
\uparrow	Н	Н	Z	Z
\uparrow	Н	L	Z	Active
\uparrow	L	Н	Active	Z
\uparrow	L	L	Active	Active

A-TO-B STORAGE (OEB = L)

Inputs				Outp	uts
CLKENA1	CLKENA2	CLK	Ах	1Bx	2Bx
Н	Н	Х	Х	1B ₀ ⁽²⁾	2B ₀ ⁽²⁾
L	Х	\uparrow	L	L	Х
L	Х	\uparrow	Н	Н	Х
Х	L	1	L	Х	L
Х	L	1	Н	Х	Н

B-TO-A STORAGE (OEA = L)

			•	,
	Inp	Outputs		
CLK	SEL	1 Bx	2Bx	Ах
Х	Н	Х	Х	A ₀ ⁽²⁾
Х	L	Х	Х	A ₀ ⁽²⁾
\uparrow	Н	L	Х	L
\uparrow	Н	Н	Х	Н
\uparrow	L	Х	L	L
\uparrow	L	Х	Н	Н

NOTES:

1. H = HIGH Voltage Level

L = LOW Voltage Level

X = Don't Care

Z = High Impedance

 \uparrow = LOW-to-HIGH transition

2. Output level before the indicated steady-state input conditions were established.

PIN DESCRIPTION

Pin Names	I/O	Description
Ax(1:12)	I/O	Bidirectional Data Port A. Usually connected to the CPU's Address/Data bus. ⁽¹⁾
1Bx(1:12)	I/O	Bidirectional Data Port 1B. Usually connected to the even path or even bank of memory. ⁽¹⁾
2Bx(1:12)	I/O	Bidirectional Data Port 2B. Usually connected to the odd path or odd bank of memory. ⁽¹⁾
CLK	Ι	Clock Input
CLKENA1	Ι	Clock Enable Input for the A-1B Register. If CLKENA1 is LOW during the rising edge of CLK, data will be clocked into register A-1B (Active LOW).
CLKENA2	Ι	Clock Enable Input for the A-2B Register. If CLKENA2 is LOW during the rising edge of CLK, data will be clocked into register A-2B (Active LOW).
SEL	Ι	1B or 2B Port Selection. When HIGH during the rising edge of CLK, SEL enables data transfer from 1B Port to A Port. When LOW during the rising
		edge of CLK, SEL enables data transfer from 2B Port to A Port.
ŌĒĀ	Ι	Synchronous Output Enable for A Port (Active LOW)
OEB1	Ι	Synchronous Output Enable for 1B Port (Active LOW)
OEB2	Ι	Synchronous Output Enable for 2B Port (Active LOW)

NOTE:

1. These pins have "Bus-Hold". All other pins are standard inputs, outputs, or I/Os.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

 $Following\,Conditions\,Apply\,Unless\,Otherwise\,Specified:$

Operating Condition: $TA = -40^{\circ}C$ to $+85^{\circ}C$

Symbol	Parameter	Test (Conditions	Min.	Typ. ⁽¹⁾	Max.	Unit
VIH	Input HIGH Voltage Level	Vcc = 2.3V to 2.7V	Vcc = 2.3V to 2.7V		_	_	V
		Vcc = 2.7V to 3.6V		2	_	_	1
VIL	Input LOW Voltage Level	Vcc = 2.3V to 2.7V		_	_	0.7	V
		Vcc = 2.7V to 3.6V		-	-	0.8	
Іін	Input HIGH Current	VCC = 3.6V	VI = VCC	-	_	±5	μA
lil	Input LOW Current	Vcc = 3.6V	VI = GND		_	±5	μA
lozh	High Impedance Output Current	Vcc = 3.6V	Vo = Vcc	_	_	±10	μA
Iozl	(3-State Output pins)		Vo = GND	_	_	±10	
Vik	Clamp Diode Voltage	VCC = 2.3V, IIN = -18mA		_	-0.7	-1.2	V
Vн	Input Hysteresis	VCC = 3.3V		_	100	_	mV
Іссь Іссн Іссz	Quiescent Power Supply Current	Vcc = 3.6V Vin = GND or Vcc		_	0.1	40	μA
∆lcc	Quiescent Power Supply Current Variation	One input at Vcc - 0.6V, othe	er inputs at Vcc or GND	—	—	750	μA

NOTE:

1. Typical values are at Vcc = 3.3V, +25°C ambient.

BUS-HOLD CHARACTERISTICS

Symbol	Parameter ⁽¹⁾	Test Conditions		Min.	Typ. ⁽²⁾	Max.	Unit
Івнн	Bus-Hold Input Sustain Current	VCC = 3V	VI = 2V	- 75	_	_	μA
IBHL			VI = 0.8V	75	_	—	
Івнн	Bus-Hold Input Sustain Current	Vcc = 2.3V	VI = 1.7V	- 45	_	_	μA
IBHL			VI = 0.7V	45	—	—	
Івнно	Bus-Hold Input Overdrive Current	Vcc = 3.6V	VI = 0 to 3.6V	—	—	±500	μA
Ibhlo							

NOTES:

1. Pins with Bus-Hold are identified in the pin description.

2. Typical values are at Vcc = 3.3V, +25°C ambient.

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Con	ditions ⁽¹⁾	Min.	Max.	Unit
Vон	Output HIGH Voltage	Vcc = 2.3V to 3.6V	Vcc = 2.3V to 3.6V IOH = -0.1mA		_	V
		Vcc = 2.3V	Iон = – 6mA	2	_	
		Vcc = 2.3V	Iон = - 12mA	1.7	_	
		Vcc = 2.7V		2.2	_	
		VCC = 3V		2.4	—	
		VCC = 3V	Iон = – 24mA	2	_	
Vol	Output LOW Voltage	Vcc = 2.3V to 3.6V	IoL = 0.1mA	—	0.2	V
		Vcc = 2.3V	IOL = 6mA	—	0.4	
			Iol = 12mA	_	0.7	
		Vcc = 2.7V	Iol = 12mA	_	0.4	
		Vcc = 3V	IOL = 24mA	_	0.55	

NOTE:

1. VIH and VIL must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate Vcc range. TA = − 40°C to + 85°C.

OPERATING CHARACTERISTICS, TA = 25°C

			$Vcc = 2.5V \pm 0.2V$	$Vcc = 3.3V \pm 0.3V$	
Symbol	Parameter	Test Conditions	Typical	Typical	Unit
Cpd	Power Dissipation Capacitance Outputs enabled	CL = 0pF, f = 10Mhz	87	120	pF
Cpd	Power Dissipation Capacitance Outputs disabled		80.5	118	

SWITCHING CHARACTERISTICS⁽¹⁾

		Vcc = 2.	5V ± 0.2V	Vcc	= 2.7V	Vcc = 3.3	3V ± 0.3V	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
fMAX		135	_	135	_	135	- 1	MHz
t PLH	Propagation Delay	1	8.2	_	7.3	1	6.2	ns
t PHL	CLK to Bx							
t PLH	Propagation Delay	1	6.4	_	5.8	1	5	ns
t PHL	CLK to Ax							
tрzн	Output Enable Time	1	7.9	_	6.7	1	6.1	ns
tPZL	Synchronous OEB: CLK to xBx							
tpzh	Output Enable Time	1	7.6	_	6.2	1	5.9	ns
tPZL	Synchronous OEA: CLK to Ax							
t PHZ	Output Disable Time	1	8.1	_	6.9	1	6.1	ns
tPLZ	Synchronous OEB: CLK to xBx							
tPHZ	Output Disable Time	1	7.5	_	6.8	1	5.6	ns
tPLZ	Synchronous OEA: CLK to Ax							
tsu	Set-up Time, Ax data before CLK↑	2	_	2	_	1.7	-	ns
tsu	Set-up Time, Bx data before CLK↑	2.2	_	2.1	_	1.8	-	ns
tsu	Set-up Time, SEL before CLK↑	1.6	_	1.6	_	1.3	-	ns
tsu	Set-up Time, CLKENA1 or CLKENA2 before CLK1	1	_	1.2	_	0.9	-	ns
tsu	Set-up Time, OE before CLK↑	1.5	_	1.6	_	1.3	-	ns
Ħ	Hold Time, Ax data after CLK↑	0.7	_	0.6	_	0.6	-	ns
Ħ	Hold Time, Bx data after CLK↑	0.7	_	0.6	_	0.6	-	ns
ťΗ	Hold Time, SEL after CLK↑	1.1	_	0.7	_	0.7	-	ns
ħ	Hold Time, CLKENA1 or CLKENA2 after CLK1	1	_	0.8	_	1.1	-	ns
ħ	Hold Time, OE after CLK↑	0.8	_	0.8	_	0.8	-	ns
tw	Pulse Width, CLK HIGH or LOW	3.3	_	3.3	_	3.3	—	ns
tsk(0)	Output Skew ⁽²⁾	_	_	_	_	-	500	ps

NOTES:

1. See TEST CIRCUITS AND WAVEFORMS. TA = -40° C to $+85^{\circ}$ C.

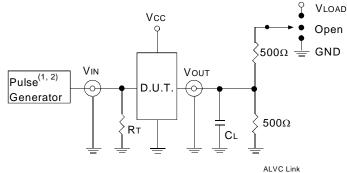
2. Skew between any two outputs of the same package and switching in the same direction.

IDT74ALVCH16269 3.3V CMOS12-BITTO24-BITREGISTERED BUS EXCHANGER

INDUSTRIAL TEMPERATURE RANGE

TEST CIRCUITS AND WAVEFORMS TEST CONDITIONS

· = • ·				
Symbol	$Vcc^{(1)} = 3.3V \pm 0.3V$	Vcc ⁽¹⁾ =2.7V	Vcc ⁽²⁾ =2.5V±0.2V	Unit
Vload	6	6	2 x Vcc	V
Vih	2.7	2.7	Vcc	V
Vτ	1.5	1.5	Vcc / 2	V
Vlz	300	300	150	mV
Vhz	300	300	150	mV
CL	50	50	30	pF



Test Circuit for All Outputs

DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

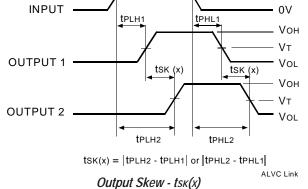
 $\mathsf{R} \mathsf{T}$ = Termination resistance: should be equal to $\mathsf{Z} \mathsf{O} \mathsf{U} \mathsf{T}$ of the Pulse Generator.

NOTES:

1. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2.5ns; tR \leq 2.5ns. 2. Pulse Generator for All Pulses: Rate \leq 1.0MHz; tF \leq 2ns; tR \leq 2ns.

SWITCH POSITION

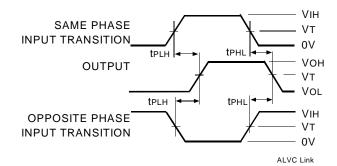
Open Drain Disable Low Enable Low	Vload
Disable High Enable High	GND
All Other Tests	Open



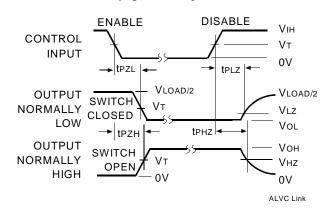
NOTES:

1. For tsk(o) OUTPUT1 and OUTPUT2 are any two outputs.

2. For tsk(b) OUTPUT1 and OUTPUT2 are in the same bank.

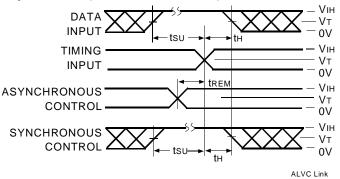


Propagation Delay

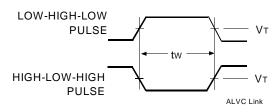


Enable and Disable Times

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.



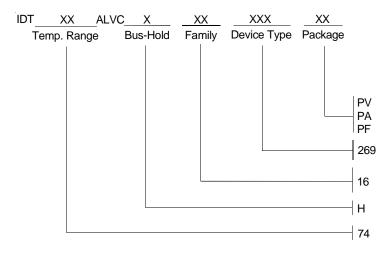
Set-up, Hold, and Release Times



Pulse Width

NOTE:

ORDERING INFORMATION



Shrink Small Outline Package Thin Shrink Small Outline Package Thin Very Small Outline Package

12-Bit to 24-Bit Registered Bus Exchanger with 3-State Outputs

Double-Density, ±24mA

Bus-Hold

– 40°C to +85°C



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